CMOS Digital Integrated Circuits Silicon Monolithic

# 74HC240D,74HC244D

#### 1. Functional Description

· Octal Bus Buffer

74HC240D: INVERTED, 3-STATE OUTPUTS 74HC244D: NON-INVERTED, 3-STATE OUTPUTS

#### 2. General

The 74HC240D and 74HC244D are high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC240D is an inverting 3-state buffer and the 74HC244D are non-inverting 3-state buffers having two active-low output enables.

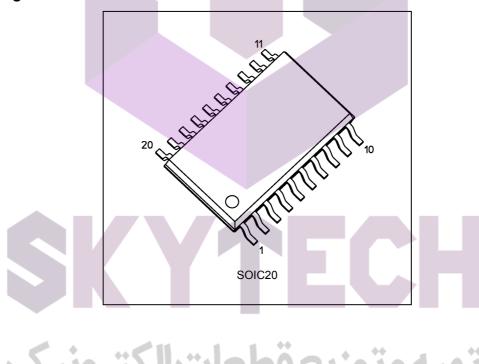
These devices are designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### 3. Features

- (1) High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 6.0 \text{ V}$
- (2) Low power dissipation:  $I_{CC} = 4.0 \mu A \text{ (max)}$  at  $T_a = 25 \text{ °C}$
- (3) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range:  $V_{CC(opr)} = 2.0 \text{ V}$  to 6.0 V

#### 4. Packaging

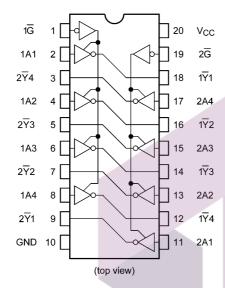


Start of commercial production

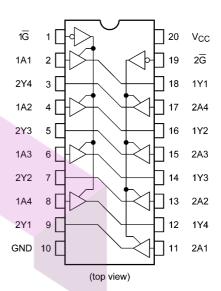


#### 5. Pin Assignment

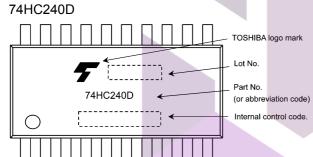
74HC240D



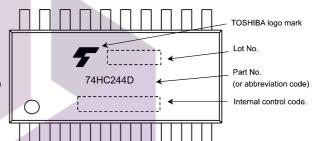
#### 74HC244D



### 6. Marking



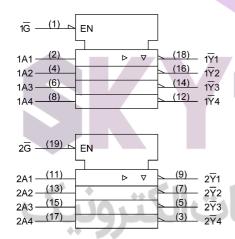
#### 74HC244D

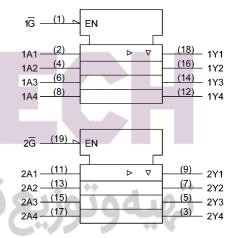


#### 7. IEC Logic Symbol

74HC240D







Rev.2.0



#### 8. Truth Table

Input G	Input An	Output Yn	Output $\overline{Y}$ n
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care
Z: High impedance
Yn: 74HC244D
\overline{Y}n: 74HC240D

#### 9. Absolute Maximum Ratings (Note)

Characteristics		Symbol	Rating	Unit
Supply voltage		V <sub>CC</sub>	-0.5 to 7.0	V
Input voltage		V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage		V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current		I <sub>IK</sub>	±20	mA
Output diode current		I <sub>OK</sub>	±20	mA
Output current		I <sub>OUT</sub>	±35	mA
V <sub>CC</sub> /ground current		Icc	±75	mA
Power dissipation		P <sub>D</sub>	500	mW
Storage temperature		T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## 10. Operating Ranges (Note)

Characteristics		Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		2.0 to 6.0	٧
Input voltage	V <sub>IN</sub>		0 to V <sub>CC</sub>	٧
Output voltage	V <sub>OUT</sub>		0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>		-40 to 85	ο̈́
Input rise and fall times	t <sub>r</sub> ,t <sub>f</sub>	V <sub>CC</sub> = 2.0 V	0 to 1000	ns
		V <sub>CC</sub> = 4.5 V	0 to 500	
		V <sub>CC</sub> = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{\text{CC}}$  or GND.





#### 11. Electrical Characteristics

# 11.1. DC Characteristics (Unless otherwise specified, $T_a$ = 25 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_	2.0	1.50	_	_	V	
			4.5	3.15	_	_		
			6.0	4.20	_	_		
Low-level input voltage	V <sub>IL</sub>	_	-			_	0.50	V
				4.5	_		1.35	
				6.0	_		1.80	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5		
				6.0	5.9	6.0		
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	
			I <sub>OH</sub> = -7.8 mA	6.0	5.68	5.80	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	2.0	_	0.0	0.1	V
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	
			I <sub>OL</sub> = 7.8 mA	6.0	/	0.18	0.26	
3-state output OFF-state leakage current	l <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	ı	±0.5	μА
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or GND	6.0	_	_	±0.1	μА	
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0			4.0	μА

# 11.2. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
			<u></u>	6.0	5.9	_	
			$I_{OH} = -6 \text{ mA}$	4.5	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.63		
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 20 μA	2.0		0.1	V
				4.5	4	0.1	
				6.0		0.1	
			$I_{OL} = 6 \text{ mA}$	4.5		0.33	
		4	$I_{OL}$ = 7.8 mA	6.0		0.33	
3-state output OFF-state leakage current	l <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$	ab gs	6.0	1041	±5.0	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_ **	±1.0	μА
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0		40.0	μА



# 11.3. AC Characteristics (Unless otherwise specified, $T_a$ = 25 °C, Input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output transition time		t <sub>TLH</sub> ,t <sub>THL</sub>			50	2.0	_	25	60	ns
						4.5		7	12	
						6.0		6	10	
Propagation delay time		t <sub>PLH</sub> ,t <sub>PHL</sub>			50	2.0	1	36	90	ns
						4.5	_	12	18	
						6.0		10	15	
					150	2.0		51	130	
						4.5	_	17	26	
						6.0	_	14	22	
Output enable time		$t_{PZL},t_{PZH}$		$R_L = 1 k\Omega$	50	2.0	_	48	125	ns
						4.5	_	16	25	
						6.0	_	14	21	
					150	2.0	_	63	165	
						4.5	_	21	33	
						6.0	_	18	28	
Output disable time		t <sub>PLZ</sub> ,t <sub>PHZ</sub>		$R_L = 1 k\Omega$	50	2.0	_	32	125	ns
						4.5	_	15	25	
						6.0	_	14	21	
Input capacitance		C <sub>IN</sub>		_			_	5	10	pF
Output capacitance		C <sub>OUT</sub>						10	_	pF
Power dissipation	74HC240D	C <sub>PD</sub>	(Note 1)	_			_	31	_	pF
capacitance	74HC244D						_	33	_	

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$ 

#### 11.4. AC Characteristics

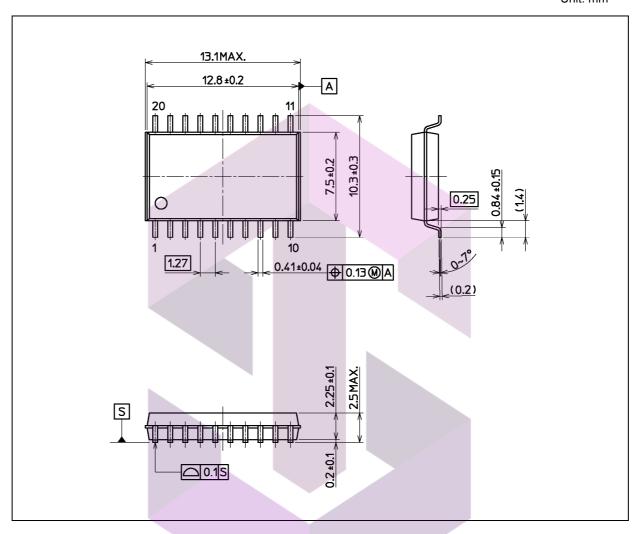
(Unless otherwise specified,  $T_a = -40$  to 85 °C, Input:  $t_r = t_f = 6$  ns)

Characteristics	Symbol	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Max	Unit											
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>	_	50	2.0	_	75	ns											
				4.5	_	15												
				6.0	_	13												
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	50	2.0	_	115	ns											
				4.5		23												
				6.0	_	20												
			150	2.0	_	165												
				4.5	_	33												
				6.0		28												
Output enable time	$t_{PZL}, t_{PZH}$	$R_L = 1 k\Omega$	50	2.0		155	ns											
	کتر	11 1		4.5		31												
			**	6.0	١,	26												
1 110		عاتالكتر						1,"10	16, 710	11"10			150	150	2.0	-10	205	
								4.5		41								
				6.0	-	35												
Output disable time	$t_{PLZ}, t_{PHZ}$	$R_L = 1 k\Omega$	50	2.0		155	ns											
				4.5		31												
				6.0		26												
Input capacitance	C <sub>IN</sub>	_			_	10	pF											



### **Package Dimensions**

Unit: mm



Weight: 0.51 g (typ.)

Package Name(s)
Nickname: SOIC20



Rev.2.0



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